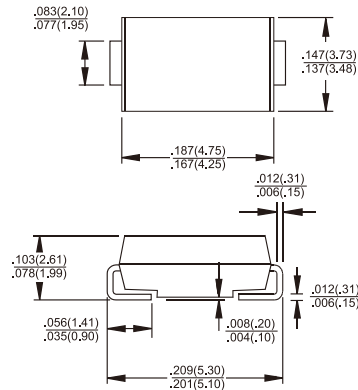




HS2A - HS2M

2.0 AMPS. High Efficient Surface Mount Rectifiers

SMB/DO-214AA



Dimensions in inches and (millimeters)

Marking Diagram



HS2X = Specific Device Code
G = Green Compound
Y = Year
M = Work Month

Features

- ◇ UL Recognized File # E-326243
- ◇ Glass passivated junction chip.
- ◇ For surface mounted application
- ◇ Low forward voltage drop
- ◇ Low profile package
- ◇ Built-in stain relief, ideal for automatic placement
- ◇ Fast switching for high efficiency
- ◇ High temperature soldering: 260°C/10 seconds at terminals
- ◇ Plastic material used carries Underwriters Laboratory Classification 94V0
- ◇ Green compound with suffix "G" on packing code & prefix "G" on datecode.

Mechanical Data

- ◇ Cases: Molded plastic
- ◇ Terminals: Pure tin plated, lead free
- ◇ Polarity: Indicated by cathode band
- ◇ Packing: 12mm tape per EIA STD RS-481
- ◇ Weight: 0.093 grams

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	HS 2A	HS 2B	HS 2D	HS 2F	HS 2G	HS 2J	HS 2K	HS 2M	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	300	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	210	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	300	400	600	800	1000	V
Maximum Average Forward Rectified Current See Fig. 1	I _{F(AV)}	2.0								A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	50								A
Maximum Instantaneous Forward Voltage @ 2.0A	V _F	1.0				1.3	1.7			V
Maximum DC Reverse Current at Rated DC Blocking Voltage @T _A =25 °C (Note 1) @ T _A =125 °C	I _R	5.0 150								uA uA
Maximum Reverse Recovery Time (Note 4)	T _{rr}	50					75			nS
Typical Junction Capacitance (Note 2)	C _j	50					30			pF
Maximum Thermal Resistance (Note 3)	R _{θJA}	80								°C/W
Operating Temperature Range	T _J	-55 to +150								°C
Storage Temperature Range	T _{STG}	-55 to +150								°C

- Notes: 1. Pulse Test with PW=300 usec, 1% Duty Cycle
2. Measured at 1 MHz and Applied VR=4.0 Volts.
3. Mounted on P.C.Board with 0.4" x 0.4" (10mm x 10mm) Copper Pad Area.
4. Reverse Recovery Test Conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Version: D10

RATINGS AND CHARACTERISTIC CURVES (HS2A THRU HS2M)

FIG.1- MAXIMUM FORWARD CURRENT DERATING CURVE

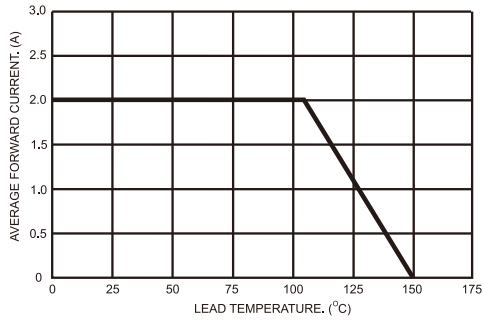


FIG.2- TYPICAL REVERSE CHARACTERISTICS

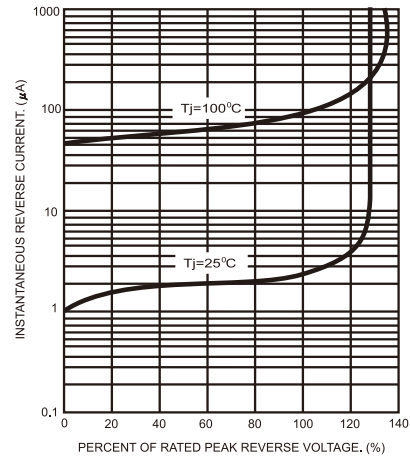


FIG.3- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

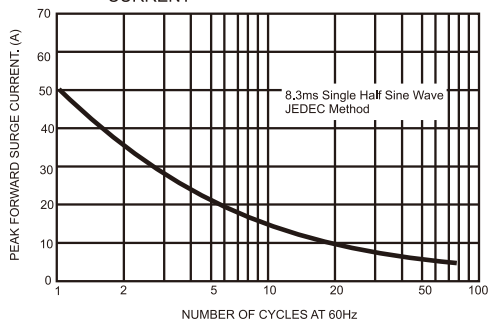


FIG.5- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

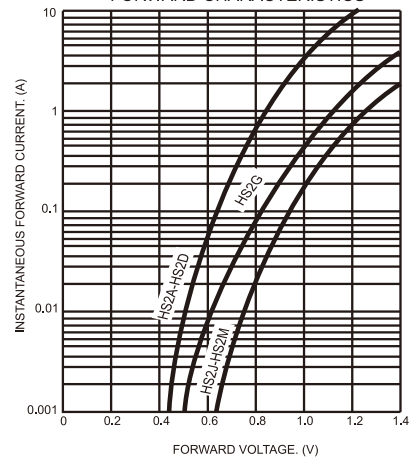


FIG.4- TYPICAL JUNCTION CAPACITANCE

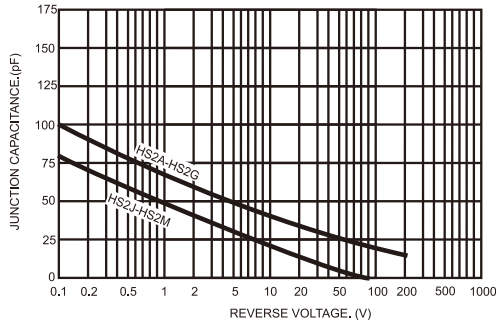


FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

